### Overview

### **HP 245 G10 Notebook PC**



#### Left

- 1. Internal Dual Digital Microphone (2)
- 2. Webcam
- 3. Camera Shutter
- 4. Webcam LED
- 5 Clickpad

- 6. Audio Combo Jack
- **7.** SuperSpeed USB Type-C<sup>®</sup> 5Gbps signaling rate1 (Supports data transfer only and does not support charging or external monitors)
- 8. HDMI Port (Cable Sold Separately)
- SuperSpeed USB Type-A 5Gbps signaling rate1 port (USB 3.2 Gen 1)

## Overview



#### Right

- 1. Power Button
- 2. Power Connector

- **3.** SuperSpeed USB Type-A 5Gbps signaling rate1 port (USB 3.2 Gen 1)
- 4. Fingerprint Reader (Select Models)

#### **Overview**

#### At a Glance

- Preinstalled with Windows 11 Pro, Windows Home or FreeDOS
- Choice of AMD Ryzen™ APU processors
- Choice of 35.56 cm (14") diagonal HD and UltraWide Viewing Angle FHD 400 nit display
- Optimize your video calls with an FHD camera(optional) and temporal noise reduction that adjusts the lighting to your environment.
- Fast dual channel DDR4 SODIMM memory up to 16 GB
- Enhanced security features including discrete TPM 2.0 for BCL-R, Firmware TPM for MDN and optional Fingerprint reader.
- Weight with basic configurations starting at 3.01lb/1.36kg
- Support wireless options for connectivity on the go including gigabit-speed up to Wi-Fi® 6
- Supports fast charging (50% in 45 minutes) with no impact on battery recharge cycles
- Full size, optional backlit keyboard and spill resistant, clickpad with Precision Touchpad Supported certified
- Camera shutter door to ensure privacy
- Undergoes MIL-STD 810H tests<sup>1</sup>

1. MIL-STD 810H is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



#### **PRODUCT NAME**

HP 245 G10 Notebook PC

#### **OPERATING SYSTEMS**

**Preinstalled** Windows 11 Pro <sup>1</sup>

Windows 11 Pro Education<sup>1</sup>

Windows 11 Home – HP recommends Windows 11 Pro for business1

Windows 11 Home Single Language – HP recommends Windows 11 Pro for business<sup>1</sup> Windows 11 Home Education – HP recommends Windows 11 Pro for business<sup>1</sup>

FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

#### **PROCESSORS**

| Processor 3.4,5          | Cores | Threads | L3 Cache | Max Boost Frequency 5 | Base Frequency |
|--------------------------|-------|---------|----------|-----------------------|----------------|
| AMD Ryzen™ 7-7730U       | 8     | 16      | 16MB     | 4.50GHz               | 2.00GHz        |
| AMD Ryzen™ 5-7530U       | 6     | 12      | 16MB     | 4.50GHz               | 2.00GHz        |
| AMD Ryzen™ 5-7520U       | 4     | 8       | 4MB      | 4.3GHz                | 2.8GHz         |
| AMD Ryzen™ 3-7330U       | 4     | 8       | 8MB      | 4.30GHz               | 2.30GHz        |
| AMD Ryzen™ 3-7320U       | 4     | 8       | 4MB      | 4.1GHz                | 2.4GHz         |
| AMD Athlon™ Silver 7120U | 2     | 2       | 2MB      | 3.5GHz                | 2.4GHz         |

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. AMD Max Boost frequency performance varies depending on hardware, software and overall system configuration.

#### **CHIPSET**

Chipset is integrated with processor



#### **GRAPHICS**

#### Integrated

AMD Radeon™ Graphics

#### **Supports**

Support HD decode, DX12, HDMI 1.4b 7

7. HD content required to view HD images.

#### **DISPLAY**

#### **Non-Touch**

35.6 cm (14") diagonal FHD UWVA eDP + PSR anti-glare Low Blue Light, narrow bezel bent, 400 nits, 100% sRGB (1920 x 1080) 7,8,9

35.6 cm (14") diagonal FHD UWVA edp anti-glare, narrow bezel bent, 250 nits, 45% NTSC (1920x1080)  $^{7,8,9}$  35.6 cm (14") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC (1366 x 768)  $^{7,8,9}$ 

#### **HDMI**

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

#### Display Size (Diagonal)

14"

35.56 cm (14")

- 7. HD content required to view HD images.
- 8. Sold separately or as an optional feature.
- 9. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

#### STORAGE AND DRIVES

#### Primary M.2 Storage

128 GB PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 SSD <sup>10</sup>
256 GB PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 SSD <sup>10</sup>
512 GB PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 SSD <sup>10</sup>
1 TB PCIe<sup>®</sup> Gen4x4 NVMe<sup>™</sup> M.2 SSD TLC <sup>10,11</sup>

10. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

11. Available only to HK (Hong Kong), TW(Taiwan) and CN (China).



## **Technical Specifications**

#### **MEMORY**

#### **Maximum Memory**

32GB DDR4-3200 SDRAM 12

#### Memory

16 GB DDR4-3200 MT/s SDRAM (1x16GB) <sup>13</sup>
16 GB DDR4-3200 MT/s SDRAM (2x8GB) <sup>13</sup>
8 GB DDR4-3200 MT/s SDRAM (1x8GB) <sup>13</sup>
8 GB DDR4-3200 MT/s SDRAM (2x4GB) <sup>13</sup>
8 GB LPDDR5-5500 MT/s (onboard) <sup>13</sup>
4 GB DDR4-3200 MT/s SDRAM (1x4GB) <sup>13</sup>
4 GB LPDDR5-5500 MT/s (onboard) <sup>13</sup>

#### Memory Slots 14

2 SODIMM (BCL-R only)
All slots are customer non-accessible / non-upgradeable
Supports Dual Channel Memory

- 12. Designed to support up to 32GB memory. Sold separately. Check with the memory manufacturer for compatibility.
- 13. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.
- 14. All slots are non-accessible / non-upgradeable.

#### **NETWORKING/COMMUNICATIONS**

#### **WLAN**

Realtek 8852BE-VS (1X1) Wi-Fi® 6 Bluetooth® 5.3 WLAN Wireless Card <sup>15</sup> Realtek 8852BE (2X2) Wi-Fi® 6 Bluetooth® 5.3 WW WLAN Wireless Card <sup>15</sup>

#### Miracast

Compatible with Miracast-certified devices (For Win11) 16

- 15. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs.
- 16. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.



## **Technical Specifications**

#### **AUDIO/MULTIMEDIA**

#### **Audio**

2 Integrated stereo speakers Integrated Microphone

#### Camera

720p HD camera with Temporal Noise Reduction <sup>7,8</sup> 1080p FHD camera with Temporal Noise Reduction <sup>7,8</sup>

- 7. HD content required to view HD images.
- 8. Sold separately or as an optional feature.

#### **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

Full Size Textured island-style Keyboard and optional Backlit and spill resistant 16

#### **Pointing Device**

Touchpad with multi-touch gesture support (PTP certified)

#### **Function Keys**

- F1 Open " How to get help in Windows 11" webpage
- F2 Brightness Down
- F3 Brightness Up
- F4 Display Switching
- F5 Blank
- F6 Mute
- F7 Volume Down
- F8 -Volume Up
- F9 Previous
- F10 Play/Pause
- F11 Next
- 16. Backlit keyboard is an optional feature.



## **Technical Specifications**

#### **SOFTWARE AND SECURITY**

#### Software

HP Smart Health<sup>17</sup>

ENERGY STAR® UWP (Universal Windows Platform for Windows)

Express VPN

Microsoft Office (Microsoft office sold separately. Internet access required for activation)

**WPS Office** 

Dropbox Promotion 18

HP QuickDrop 19

E-OR Code

sMedio True DVD for HP

#### **Manageability Features**

HP SSRM (HP Support Sent Recovery Media) <sup>20</sup> Windows Push Button Reset Recovery <sup>21</sup>

#### **Security Management**

McAfee LiveSafe™ 22

17. HP Smart Health requires HP TechPulse, a telemetry and analytics platform that provides critical data around devices and applications and is not sold as a standalone service. HP TechPulse follows stringent GDPR privacy regulations and is ISO27001, ISO27701, ISO27017 and SOC2 Type2 certified for Information Security. Internet access with connection to TechPulse portal is required. For full system requirements, please visit http://www.hpdaas.com/requirements. Purchase of any HP TechPulse-enabled service necessitates enabling software to run on each device. HP Services Scan is provided thru Windows Update and will check entitlement on each hardware device to determine if an HP TechPulse-enabled service has been purchased, and will download applicable software automatically. To disable this feature, please follow the instructions at http://www.hpdaas.com/requirements.

18. 100 GB of free Dropbox storage for 12 months from date of registration. For complete details and terms of use, including cancellation policies, visit the Dropbox website at https://www.dropbox.com/help/space/hp-promotion. Internet service required and not included.

19. HP Quick Drop requires Internet access and Windows 10 and higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

- 20. Sold separately or as an optional feature.
- 21. Must activate within 180 days of Windows activation.
- 22. 30-day McAfee® LiveSafe™ trial included. Internet access required and not included. Subscription required after expiration. See http://www.McAfee.com for more details.



#### **POWER**

#### **Power Supply**

HP Smart 65 W EM External AC power adapter <sup>23</sup> HP Smart 45 W External AC power adapter<sup>23</sup>

#### **Battery**

HP Long Life 3-cell, 41 Wh Li-ion Polymer 24,25

#### **Power Cord**

1M (3.28 feet) length power cord

#### **Battery Life**

Up to 12 hours and 17 minutes with 41 whr battery(HP Long Life 3-Cell, 41 Whr Polymaer, UMA graphic, AMD BCL-R, display set to 200 nits, 8G memory, 512 GB SSD) <sup>26</sup>

#### **Battery Weight**

 $0.18 \, \mathrm{kg}$ 

0.39 lb

- 23. Availability may vary by country.
- 24. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 25. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.
- 26. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

#### **WEIGHTS & DIMENSIONS**

#### **Product Weight**

Starting at 3.01 lb <sup>27</sup> Starting at 1.36 kg <sup>27</sup>

#### Product Dimensions (W x D x H)

12.76 x 8.46 x 0.70 in 32.4 x 21.5 x 1.79 cm

#### Packaging Dimensions (W x D x H) 28

12-15" boxes (305mm height): 1200mm x 1000mm x 1080mm

- 27. Weight will vary by configuration. Does not include power adapter.
- 28. Product packaging size varies based on options chosen. Please contact your HP representative for your packaging size details.



## **Technical Specifications**

#### **PORTS/SLOTS**

- 2 SuperSpeed USB Type-A 5Gbps signaling rate
- 1 SuperSpeed USB Type-C® 5Gbps signaling rate (Supports data transfer only and does not support charging or external monitors)
- 1 HDMI v1.4b 29
- 1 AC Power
- 1 Headphone/microphone combo jack
- 29. HDMI cable sold separately

#### **SERVICE AND SUPPORT**

1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.<sup>30</sup>

30. HP Care Packs are sold separately. Service levels and response ties for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



#### **SYSTEM UNIT**

**Stand-Alone Power Requirements** 

(AC Power)

Nominal Operating Voltage 19.5V

Average Operating Power 3.84W (Local video playback)

Integrated graphics Yes
Discrete Graphics N/A

Max Operating Power UMA < 45W

**Temperature** 

Operating 32° to 95° F (0° to 35° C) (not writing optical)

41° to 95° F (5° to 35° C) (writing optical)

Non-operating -4° to 140° F (-20° to 60° C)

**Relative Humidity** 

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

**Random Vibration** 

Operating 1.043 grams
Non-operating 3.5 grams

Altitude (unpressurized)

Operating -50 to 10,000 ft (-15.24 to 3,048 m)
Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

**Planned Industry Standard** 

**Certifications** 

Regulatory Model Number TPN-I141 CSA/UL 62368-1 Yes

ENERGY STAR® Certified 31

EPEAT® Gold in the United States 32

FCC/ICES/CISPR/VCCI Yes
CE MARKING Yes
GS Mark Yes

Related commodity should comply with ISO 9241 Standards.

China CCC/SRRC Yes Taiwan BSMI/NCC Yes Korea KCC/KC/KES Yes Ukraine NSoC/TEC Yes **EAEU Compliance** Yes Saudi Arabian Compliance Yes TCO No **WW RoHS** Yes Low Blue Light Yes

31. Configurations of the HP 245 G10 Notebook PC that are ENERGY STAR® qualified are identified as HP 245 G10 Notebook PC ENERGY STAR on HP websites and on http://www.energystar.gov.



32. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information.

#### **DISPLAYS**

1. Actual brightness will be lower with touchscreen or HP Sure View.

**NOTE:** All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14.0 in FHD (1920 x 1080) Anti-Glare UWVA LED NTSC 45 NB2X 250 eDP 1.2 w/o PSR Low-Power flat LCD Panel **Outline Dimensions (W x H x D)** 315.070±0.3x192.270±0.5 [W/ PCB]

**Active Area** 309.310 x 173.990

Weight 285 g max

Diagonal Size 14 (inch)

Surface Treatment Anti-Glare

Touch Enabled No

**Contrast Ratio** 1000:1 (typ.)

Refresh Rate 60Hz
Brightness 250nits<sup>1</sup>

Pixel Resolution - Format 1920\*1080 (FHD)

BacklightWLEDPixel ResolutionRGBColor Gamut CoverageNTSC 45%

**Color Depth** 8 bits

Viewing Angle UWVA 89/89/89/89

**Low Blue Light** No

Power Consumption (W, EBL@ 150nits max/ 200nits max)

1.50W max/ 1.87W max

Panel LCD 14-in HD (1366x768) Anti-Glare WLED SVA 45percent cg 250nits eDP NWBZ ultraslim **Outline Dimensions (W x H)** 315.900+/-0.3 x 197.550 +/- 0.3

**Active Area** 309.400 x 173.950

Weight 285g Max
Diagonal Size 14 (inch)
Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio300:1 (typ)Refresh Rate60HzBrightness250nits1

Pixel Resolution - Format 1366 x 768 (HD)

BacklightWLEDPixel ResolutionRGBColor Gamut CoverageNTSC 45%

**Color Depth** 6 bits

Viewing Angle SVA 45/45/15/30



## **Technical Specifications**

**Low Blue Light** 

No

Power Consumption (W, EBL@ 150nits max/ 200nits max)

2.52W max./ <2.86W max.



## **Technical Specifications**

#### STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

SSD 128GB 2230 PCIe NVMe Form Factor QLC (SSD 128GB 2230 PCIe Capacity NVMe QLC)

Form Factor M.2 2230
Capacity 128GB
NAND Type QLC

InterfacePCIe NVMeLogical Blocks250,069,680

**Features** Pyrite

SSD 1TB 2280 PCIe NVMe QLC (1TB 2280 PCIe NVMe QLC 2nd Solid State Drive) Form Factor M.2 2280
Capacity 1TB
NAND Type QLC

InterfacePCIe NVMeLogical Blocks2,000,409,264

**Features** Pyrite

SSD 256GB 2280 PCIe NVMe QLC (SSD 256GB 2280 PCIe NVMe QLC) Form Factor M.2 2280
Capacity 256GB
NAND Type QLC

InterfacePCIe NVMeLogical Blocks500,118,192FeaturesPyrite

SSD 512GB 2280 PCIe NVMe QLC Form Factor M.2 2280
Capacity 512GB
NAND Type QLC

InterfacePCIe NVMeLogical Blocks1,000,215,216

**Features** Pyrite

SSD 1 TB 2280 PCIe NVMe Value<sup>1</sup> Form Factor M.2 2280
Capacity 1TB
NAND Type TLC

InterfacePCIe NVMe Gen4X4Maximum Sequential Read3200 MB/s ±20%Maximum Sequential Write2700 MB/s ±20%Logical Blocks2,000,409,264

**Features** Pyrite 2.0; TRIM; L1.2

1. Available only to HK (Hong Kong), TW (Taiwan) and CN (China).



#### **NETWORKING/COMMUNICATIONS**

| Realtek RTL8852BE       | <b>Wireless LAN Standards</b> | IEEE 802.11a  |
|-------------------------|-------------------------------|---------------|
| 802.11ax 2x2 Wi-Fi +    |                               | IEEE 802.11b  |
| Bluetooth® 5.3 Wireless |                               | IEEE 802.11g  |
| Card (802.11ax 2x2,     |                               | IEEE 802.11n  |
| supporting gigabit data |                               | IEEE 802.11ac |
| rate) <sup>1</sup>      |                               | IEEE 802.11ax |
|                         |                               | IEEE 802.11d  |

IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Interoperability Wi-Fi certified modules

Frequency Band •802.11b/g/n/ax

2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

**Data Rates** • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps802.11ac: max 866.7Mbps802.11ax: max 1201Mbps

**Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

• IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationWPA3 certificationIEEE 802.11i

WAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

Output Power<sup>3</sup> • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum



• 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ax HE40(2.4GHz): +10dBm minimum
802.11ax HE80(5GHz): +10dBm minimum

**Power Consumption** • Transmit mode :2.5 W

• Receive mode: 2 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode :50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity**<sup>4</sup> 802.11b, 1Mbps : -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

•802.11ax, MCS11(HE40): -57dBm maximum •802.11ax, MCS11(HE80): -54dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230 : 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230 : 2.8g

2. Type 126: 1.3g

Operating Voltage 3.3v +/- 9%

**Temperature Operating** 14° to 158° F (–10° to 70° C)

**Non-operating**  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity Operating** 10% to 90% (non-condensing)

**Non-operating** 5% to 95% (non-condensing)

**Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber – Radio OFF;

LED OFF - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1 Compliant/5.2 Compliant/5.3 Compliant





Frequency Band 2402 to 2480 MHz

Number of Available Legacy : 0~79 (1 MHz/CH)
Channels BLE : 0~39 (2 MHz/CH)

**Signaling Data Rate** Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

1. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.

- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek RTL8852BE-VS 802.11ax 1x1 Wi-Fi 6+ Bluetooth® 5.3 Wireless Card (802.11ax 1x1) 1 Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d

> IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k

Interoperability Wi-Fi certified modules

Frequency Band •802.11b/g/n/ax

2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz

5.825 - 5.850 GHz

• 802.11b: 1. 2. 5.5. 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 150Mbps



## **Technical Specifications**

802.11ac : max 433Mbps

• 802.11ax: max 600Mbps

**Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

• IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationWPA3 certificationIEEE 802.11i

WAPIEAP

Network Architecture Models Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

Output Power<sup>3</sup> • 802.11b: +17dBm minimum

• 802.11g : +16dBm minimum • 802.11a : +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
802.11n HT40(2.4GHz): +13dBm minimum
802.11n HT20(5GHz): +14dBm minimum
802.11n HT40(5GHz): +13dBm minimum
802.11ac VHT80(5GHz): +10dBm minimum
802.11ax HE40(2.4GHz): +12dBm minimum
802.11ax HE80(5GHz): +10dBm minimum

Power Consumption • Transmit mode :2.5 W

• Receive mode: 2 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode :50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>4</sup>** 802.11b, 1Mbps : -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

•802.11ax, MCS11(HE40): -57dBm maximum •802.11ax, MCS11(HE80): -54dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure



Two embedded dual band 2.4/5 GHz antennas are provided to the card to

support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230 : 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230 : 2.8g

2. Type 126: 1.3g

Operating Voltage 3.3v +/- 9%

**Temperature Operating** 14° to 158° F (-10° to 70° C)

**Non-operating**  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity Operating** 10% to 90% (non-condensing)

**Non-operating** 5% to 95% (non-condensing)

**Altitude Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber – Radio OFF;

LED OFF - Radio ON

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1 Compliant/5.2 Compliant/5.3 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy : 0~79 (1 MHz/CH)
Channels BLE : 0~39 (2 MHz/CH)

**Data Rates and**Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

1. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.

- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



## **Technical Specifications**

#### **POWER**

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

HP 45W Smart AC adapter Dimensions (H x W x D) 3.74 x 1.772 x 1.043 in (9.5x4.5x2.65cm)

> Weight 0.44 lb (200 g) max (Not including power cord. Power cord varies by

> > country.)

Input 100-240Vac

> **Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230 Vac

Input frequency range 47-63 Hz

Max. 1.4 A at 90 Vac **Input AC current** 

Output **Output power** 45W

> **DC** output 19.5V

Hold-up time 100% load 5ms at 115 Vac input/80% load

10ms at 115 Vac input

**Output current limit** < 8.0A

Connector 4.5mm Barrel Type

**Environmental Design Operating** 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety** CE Mark - full compliance with LVD and EMC directives Certifications

Worldwide safety standards - IEC60950-1 and IEC62368-1: 2018.

EN62368-1:2014+A11, UL62368-1

Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia GEMS and RCM, BIS, BSMI, UAE, UKCA DoC

65W EM Adapter Dimensions (H x W x D) 4.016 x 2.165 x 1.181 in (10.2x5.5x3cm)

> Weight 0.58 lb (265 g) max

> > (Not including power cord. Power cord varies by country.)

100-240Vac Input

> **Input Efficiency** 88 % at 115 Vac and 89 % at 230Vac

Input frequency range 47-63 Hz

Max. 1.7 A at 90 Vac **Input AC current** 

65W Output **Output power** 

> **DC** output 19.5V

Hold-up time 100% load 5ms at 115 Vac input/80% load

10ms at 115 Vac input

**Output current limit** < 11.0A



**Connector** 4.5mm Barrel Type

**Environmental Design** Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety** CE Mark - full compliance with LVD and EMC directives

**Certifications** Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018,

EN62368-1:2014+A11, UL62368-1

Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia GEMS and RCM, BIS, BSMI, UAE, UKCA DoC

HP 3-cell Long Life Li-Ion Weight (41 Wh)<sup>1</sup>

**Weight** 0.185 kg (0.407 lb)

Cells/Type 3cell Lithium-Ion Polymer cell / 515974

**Energy Voltage** 11.25V

Amp-hour capacity 3.648Ah Watt-hour capacity 41.04Wh

**Temperature Operating (Charging)** 32° to 113° F (0° to 45° C)

**Operating (Discharging)** 14° to 122° F (-10° to 60° C)

Optional Travel Battery No

Available

## **Technical Specifications**

#### **AUDIO**

HD Stereo Codec Realtek ALC3247

**Audio I/O Ports**One Headset Combo-Jack connector support CTIA spec.

Internal Speaker Amplifier 2W class D stereo amplifier for the internal speaker only. External speakers must be powered.

Multi-streaming Capable Playback multi-streaming can be enabled in the audio control panel to allow independent audio

streams to be sent to/from the Combo jack or integrated speaker.

Sampling Independent sampling rates for DAC's and ADC's; supports resolutions from 16 to 24-bit; 44.1

kHz to 48 kHz for DAC and ADC.

Wavetable Syntheses Yes - Uses OS soft wavetable

#### FINGERPRINT READER

Sensor vendorELAN EFSA80SWSensor typeCapacitiveDPI resolution508 DPIScan area80 x 80 pixelsFalse Rejection RateFRR=≤ 3%False Acceptance Rate< 1:100K</th>

**Mobile Voltage Operation** 3.0V to 3.6V

**Operating Temperature**  $-4^{\circ}F \sim 176^{\circ}F (-20^{\circ}C \sim 80^{\circ}C)$ 

50mA Peak

**Current Consumption** 

Image

Low Latency Wait For 300uA

**Finger** 

Capture Rate 50 frame/ sec

**ESD Resistance** IEC 61000-4-2 4B (+15KV) **Detection Matrix** 508 DPI / 4 mm x 4mm



## **Technical Specifications**

#### **ENVIRONMENTAL DATA**

| ENVIRONMENTAL DATA           |  |                               |  |  |  |  |
|------------------------------|--|-------------------------------|--|--|--|--|
| Eco-Label Certifications &   | This product has received or is in the process of being certified to the following approvals and may   |                               |  |  |  |  |
| declarations                 | be labeled with one or mor   | re of these marks:            |  |  |  |  |
|                              | IT ECO declaration   |                               |  |  |  |  |
|                              | US ENERGY STAR®  | 9                             |  |  |  |  |
|                              | US Federal Energy  | , Management Program (FEM     | P)                                       |  |  |  |
|                              |  |                               | ee http://www.epeat.net for registration |  |  |  |
|                              | status in your cou   |                               | ee http://www.epeat.net for registration |  |  |  |
|                              | •  | •                             |  |  |  |  |
|                              |  | servation Program (CECP)      | ·· (CEDA)                                |  |  |  |
|                              |  | onmental Protection Administ  | ration (SEPA)                            |  |  |  |
|                              | Taiwan Green Mar   | rk                            |  |  |  |  |
|                              | <ul> <li>Korea Eco-label</li> </ul>  |                               |  |  |  |  |
|                              | <ul> <li>Japan PC Green la</li> </ul>  | bel*                          |  |  |  |  |
| Sustainable Impact           | Product Carbon Footprint   | t (hp.com)                    |  |  |  |  |
| Specifications .             | Ocean-bound plastic in sp  |                               |  |  |  |  |
| -                            | • 10% post-consumer recy   |                               |  |  |  |  |
|                              | • Low halogen  | ·                             |  |  |  |  |
|                              |  | ted cushions are 100% sustai  | nably sourced and recyclable             |  |  |  |
|                              | _  | on inside box is 100% sustain |  |  |  |  |
|                              | Bulk packaging available   |                               | ably sourced and recyclable              |  |  |  |
| System Configuration         |  |                               | Declared Noise Emissions data for the    |  |  |  |
| Jystem comigaration          |  | on a "Typically Configured No |  |  |  |  |
| Energy Consumption           |  |                               |  |  |  |  |
| (in accordance with US       |  |                               |  |  |  |  |
| ENERGY STAR® test            |  |                               |  |  |  |  |
| method)                      | 115VAC, 60Hz   | 230VAC, 50Hz                  | 100VAC, 50Hz                             |  |  |  |
| Normal Operation (Sort       | 4.45 W   | 4.35 W                        | 4.31 W                                   |  |  |  |
| idle)                        |  |                               |  |  |  |  |
| Normal Operation (Long       | 0.54 W   | 0.57 W                        | 0.5 W                                    |  |  |  |
| idle)                        |  |                               |  |  |  |  |
| Sleep                        | 0.54 W   | 0.57 W                        | 0.5 W                                    |  |  |  |
| Off                          | 0.15 W   | 0.17 W                        | 0.15 W                                   |  |  |  |
|                              | 0.13 11  | 0.17 W                        | 5.13 W                                   |  |  |  |
|                              | NOTE:  |                               |  |  |  |  |
|                              | Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. |                               |  |  |  |  |
|                              |  |                               |  |  |  |  |
|                              | Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model  |                               |  |  |  |  |
|                              | family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is   |                               |  |  |  |  |
|                              | for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a   |                               |  |  |  |  |
|                              | Microsoft Windows® operating system.   |                               |  |  |  |  |
|                              |  |                               |  |  |  |  |
| Heat Dissipation*            | 115VAC, 60Hz   | 230VAC, 50Hz                  | 100VAC, 50Hz                             |  |  |  |
| Normal Operation (Short      |  | _                             |  |  |  |  |
| idle)                        | 15.2 BTU/hr  | 14.9 BTU/hr                   | 14.7 BTU/hr                              |  |  |  |
|                              |  |                               |  |  |  |  |
| Normal Operation (Long       |  |                               |  |  |  |  |
| Normal Operation (Long idle) | 1.8 BTU/hr   | 1.9 BTU/hr                    | 1.7 BTU/hr                               |  |  |  |



## **Technical Specifications**

| Off                              | 0.5 BT  | U/hr  | 0.6 BT                              | U/hr         |                    | 0.5 BTU/hr                    |
|----------------------------------|---|---|-------------------------------------|--------------|--------------------|-------------------------------|
|                                  | *NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.   |   |                                     |              |                    |                               |
| Declared Noise Emissions         |   | Sound Powe  | <br>r                               |              | Sound P            | Pressure                      |
| (in accordance with              |   | (L <sub>wAd</sub> , bels)                                     | •                                   |              |                    | ecibels)                      |
| ISO 7779 and ISO 9296)           |   | ,,  |                                     |              | , p,               |                               |
| Typically Configured – Idle      |   | 1.1   |                                     |              | 11                 | .0                            |
| Fixed Disk – Random writes       |   | 3.6   |                                     |              | 35.9               |                               |
| Optical Drive – Sequential reads | N/A N/A   |   |                                     | /A           |                    |                               |
| Longevity and Upgrading          | -   |   | ded, possibly e<br>nts contained ir | _            | seful life by seve | eral years. Upgradeable       |
|                                  | Spare parts a production.   | re available 1  | throughout the                      | warranty per | iod and or for up  | to "5" years after the end of |
| Additional Information           | <ul> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net</li> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> <li>This product is 92.8% recycle-able when properly disposed of at end of life.</li> </ul> |   |                                     |              |                    |                               |
| Packaging Materials              | External:   | PAPER/Corrugated  |                                     |              | 215 g              |                               |
|                                  |   | PAPER/Corrugated  |                                     | 41 g         |                    |                               |
|                                  |   | PAPER/Molded Pulp   |                                     |              | 50 g               |                               |
|                                  |   | ·   |                                     |              |                    |                               |
|                                  | Intornal  | PAPER/Paper Internal: PLASTIC/Polyethylene low density - LDPE |                                     |              | nc .               | 2 g                           |
|                                  | Internal: PLASTIC/Polyethylene low density - LDPE 13 g  The plastic packaging material contains at least 0.0% recycled content.   |   |                                     |              |                    |                               |
|                                  | The corrugated paper packaging materials contains at least 53.0% recycled content.  |   |                                     |              |                    |                               |
| RoHS Compliance                  | HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.   |   |                                     |              |                    |                               |
|                                  | We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.  |   |                                     |              |                    |                               |
|                                  | We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the   |   |                                     |              |                    |                               |



## **Technical Specifications**

|                 | scope of the commitment to include further restricted substances as regulations continue to evolve.   |
|-----------------|---|
|                 | To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.   |
| Material Usage  | This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at <a href="http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html">http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html</a> ):   |
|                 | <ul> <li>Asbestos</li> <li>Certain Azo Colorants</li> <li>Certain Brominated Flame Retardants – may not be used as flame retardants in plastics</li> <li>Cadmium</li> <li>Chlorinated Hydrocarbons</li> <li>Chlorinated Paraffins</li> <li>Bis(2-Ethylhexyl) phthalate (DEHP)</li> <li>Benzyl butyl phthalate (BBP)</li> <li>Dibutyl phthalate (DBP)</li> <li>Diisobutyl phthalate (DIBP)</li> <li>Formaldehyde</li> <li>Halogenated Diphenyl Methanes</li> <li>Lead carbonates and sulfates</li> <li>Lead and Lead compounds</li> <li>Mercuric Oxide Batteries</li> <li>Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.</li> <li>Ozone Depleting Substances</li> <li>Polybrominated Biphenyls (PBBs)</li> <li>Polybrominated Biphenyl Ethers (PBBEs)</li> <li>Polybrominated Biphenyl Oxides (PBBOs)</li> <li>Polychlorinated Biphenyls (PCB)</li> <li>Polychlorinated Terphenyls (PCT)</li> <li>Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.</li> </ul> |
|                 | <ul> <li>Radioactive Substances</li> <li>Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)</li> </ul>  |
| Packaging Usage | <ul> <li>HP follows these guidelines to decrease the environmental impact of product packaging:</li> <li>Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>   |





| End-of-life Management and Recycling | HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.  The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for |  |  |  |  |  |  |
|--------------------------------------|---|--|--|--|--|--|--|
|                                      | each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers.  |  |  |  |  |  |  |
|                                      | These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.   |  |  |  |  |  |  |
| HP, Inc. Corporate<br>Environmental  | For more information about HP's commitment to the environment:  |  |  |  |  |  |  |
| Information                          | Global Citizenship Report   |  |  |  |  |  |  |
|                                      | http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html  Eco-label certifications  http://www8.hp.com/us/en/hp-information/environment/ecolabels.html  |  |  |  |  |  |  |
|                                      |   |  |  |  |  |  |  |
|                                      |   |  |  |  |  |  |  |
|                                      | ISO 14001 certificates:   |  |  |  |  |  |  |
|                                      | http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and   |  |  |  |  |  |  |
|                                      | http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf   |  |  |  |  |  |  |
| footnotes                            | Percentage of ocean-bound plastic contained in each component varies by product   |  |  |  |  |  |  |
|                                      | <ul> <li>Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018<br/>standard.</li> </ul>  |  |  |  |  |  |  |
|                                      | External power supplies, WWAN modules, power cords, cables and peripherals excluded.  |  |  |  |  |  |  |
|                                      | <ul> <li>100% outer box packaging and corrugated cushions made from sustainably sourced<br/>certified and recycled fibers.</li> </ul>   |  |  |  |  |  |  |
|                                      | Fiber cushions made from 100% recycled wood fiber and organic materials.  |  |  |  |  |  |  |
|                                      | Plastic cushions are made from >90% recycled plastic.   |  |  |  |  |  |  |

### **COUNTRY OF ORIGIN**

China



## Options and Accessories (Sold separately and availability may vary by country)

| Туре           | Description   | Part Number        |
|----------------|---|--------------------|
| Audio          | HP Wired USB-A Stereo Headset   | 428K6AA            |
|                | HP Wired 3.5mm Stereo Headset   | 428K7AA            |
| <b>S</b> anaa  | IID Dualisda C2 15 C. Daalisaadi  | 1570644            |
| Cases          | HP Prelude G2 15.6 Backpack   | 1E7D6AA<br>1E7D7AA |
|                | HP Prelude G2 15.6 Top Load   | 1X644AA            |
|                | HP Prelude Pro Recycled 15.6 Backpack   |                    |
|                | HP Prelude Pro Recycled 15.6 Top Load   | 1X645AA            |
|                | HP Renew Business 14.1 Laptop Bag   | 3E5F9AA            |
|                | HP Renew Business 14.1 Laptop Sleeve  | 3E2U7AA            |
|                | HP Renew Business 15.6 Laptop Bag   | 3E5F8AA            |
|                | HP Renew Business 17.3 Laptop Backpack  | 3E2U5AA            |
|                | HP Renew Business 17.3 Laptop Bag   | 3E2U6AA            |
|                | HP Renew Executive 14.1 Laptop Sleeve   | 6B8Y3AA            |
|                | HP Renew Executive 16 Laptop Backpack   | 6B8Y1AA            |
|                | HP Renew Executive 16 Laptop Bag  | 6B8Y2AA            |
|                | HP Travel 18L 15.6 Iron Gray Laptop Backpack                                    | 6H2D9AA            |
|                | HP Travel 25L 15.6 Iron Gray Laptop Backpack                                    | 6H2D8AA            |
| Adapter        | HP USB-C to RJ45 Adapter G2   | 4Z527AA            |
|                | HP USB 3.0 to Gigabit RJ45 Adapter G2   | 4Z7Z7AA            |
|                | HP HDMI to VGA Adapter  | H4F02AA            |
| Keyboard/Combo | HP 125 WD USB Keyboard  | 266C9AA            |
| -              | HP 320K WD USB Keyboard   | 9SR37AA            |
|                | HP 155 Wired Mouse and Keyboard Combo   | 5B8COAA#ACJ        |
|                | HP 225 Antimicrobial Wired Mouse and Keyboard Combo                             | 286K3AA#AB2        |
|                | HP 225 Wired Mouse and Keyboard Combo   | 286J4AA            |
|                | HP 235 Wireless Mouse and Keyboard Combo  | 1Y4D0AA            |
|                | HP Wired Desktop 320MK Mouse and Keyboard                                       | 9SR36AA            |
| Mouse          | HP 125 USB-A Wired Mouse  | 265A9AA            |
| House          | HP 128 USB Laser Wired Mouse  | 265D9AA            |
|                | HP 155 USB-A Wired Mouse  | 5B8B7AA#ACJ        |
|                | HP 320M USB-A Wired Mouse   | 9VA80AA            |
|                | HP USB-A+Bluetooth Travel Bluetooth Mouse                                       | 6SP30AA            |
|                | HP USB Premium Wireless Mouse   | 1JR31AA            |
|                | HP 435 Bluetooth 5.0 + Wireless 2.4GHz Multi-Device Wireless Mouse              | 3B4Q5AA            |
|                | וור אט.ט בעפיטטנוו איזיי איזיי שייני איזייט בעניי אווענוי־טפעונע אווענפאט Mouse | ААСУРОС            |
| Commodity      | HP USB DVD-Writer EXT ODD   | F2B56AA            |
|                |   |                    |



Options and Accessories (Sold separately and availability may vary by country)

**Video** HP 325 FHD USB-A Webcam 53X27AA



## **Change Log**

| Date of change:  | Version History: |         | Description of change:                                     |
|------------------|------------------|---------|--|
| March 21, 2023   | V1 to V2         | Added   | Environmental Data and update call out in Overview section |
| March 30, 2023   | V2 to V3         | Updated | Ports and Slots section                                    |
| April 19, 2023   | V3 to V4         | Updated | At a Glance section  |
| May 18, 2023     | V4 to V5         | Updated | Storage and Drives section                                 |
| August 1, 2023   | V5 to V6         | Updated | Environmental Data   |
| October 24, 2023 | V6 to V7         | Added   | AMD Athlon™ Silver 7120U Processor                         |
| April 24, 2024   | V7 to V8         | Updated | Memory Section   |
| March 10, 2025   | V8 to V9         | Updated | Memory Section   |
|                  |                  |         |  |

© Copyright 2025 HP Development Company, L.P. The information contained herein is subject to change without notice. The only warranties for HP products and services are set forth in the express warranty statements accompanying such products and services. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

AMD and Radeon are trademarks of Advanced Micro Devices, Inc. Bluetooth is a trademark owned by its proprietor and used by HP Inc. under license. USB Type-C® and USB-C® are registered trademarks of USB Implementers Forum. ENERGY STAR is a registered trademark of the U.S. Environmental Protection Agency. All other trademarks are the property of their respective owners.

